



S1A/B - S1M/B

1.0A SURFACE MOUNT GLASS PASSIVATED RECTIFIER

Features

- Glass Passivated Die Construction for High Reliability
- Surge Overload Rating to 30A Peak
- Ideally Suited for Automated Assembly
- Lead Free Finish/RoHS Compliant (Note 1)
- Green Molding Compound (No Halogen and Antimony) (Note 2)
- Qualified to AEC-Q101 Standards for High Reliability

Mechanical Data

- Case: SMA/SMB
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208 (3)
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (approximate)

SMB - 0.093 grams (approximate)





Top View

Bottom View

Ordering Information (Note 3)

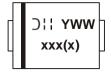
Part Number	Qualification	Case	Packaging
S1x-13-F	Commercial	SMA	5000/Tape & Reel
S1xB-13-F	Commercial	SMB	3000/Tape & Reel

^{*} x = Device type, e.g. S1A-13-F (SMA package); S1AB-13-F (SMB package).

Notes:

- 1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see EU Directive 2002/95/EC Annex Notes.
- 2. Product manufactured with Data Code 0924 (week 24, 2009) and newer are built with Green Molding Compound.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



XXX = Product type marking code, ex: S1A (SMA package)
XXXX = Product type marking code, ex: S1AB (SMB package)
311 = Manufacturers' code marking

YWW = Date code marking Y = Last digit of year (ex: 2 for 2002) WW = Week code (01 to 53)



Maximum Ratings @TA = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%.

Characteristic	Symbol	S1 A/AB	S1 B/BB	S1 D/DB	S1 G/GB	S1 J/JB	S1 K/KB	S1 M/MB	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	V _{R(RMS)}	35	70	140	280	420	560	700	V
Average Rectified Output Current @ T _T = 100°C	lo				1.0				Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load	I _{FSM}				30				Α

Thermal Characteristics

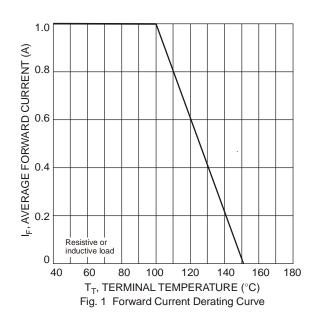
Characteristic	Symbol	Value	Unit	
Typical Thermal Resistance, Junction to Terminal (Note 4)	$R_{ hetaJT}$	30	°C/W	
Operating and Storage Temperature Range	$T_{J_1}T_{STG}$	-65 to +150	°C	

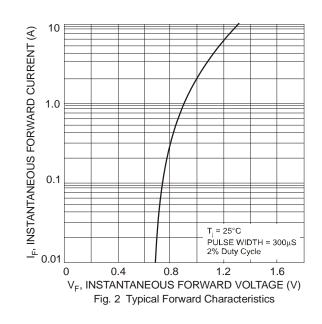
Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic		Symbol	Min	Тур	Max	Unit
Forward Voltage	$@ I_F = 1.0A$	V_{FM}	=	=	1.1	V
Peak Reverse Leakage Current	@ $T_A = 25^{\circ}C$		-	-	5.0	^
at Rated DC Blocking Voltage	@ $T_A = 125^{\circ}C$	IRM	-	-	100	μΑ
Reverse Recovery Time (Note 5)		t _{rr}	-	1.8	3.0	μS
Typical Total Capacitance (Note 6)		C _T	-	10	-	pF

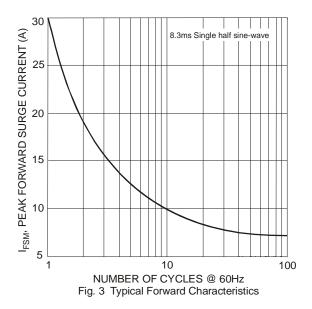
Notes: 4. Thermal resistance junction to terminal, unit mounted on PC board with 5.0 mm2 (0.013 mm thick) copper pads as heat sink.

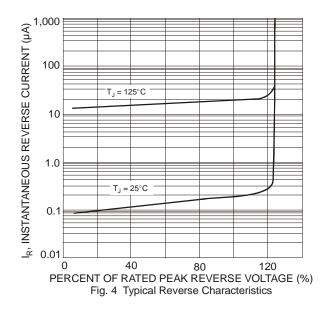
5. Measured with I_F = 0.5A, I_R = 1.0A, I_{RR} = 0.25A.
6. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.



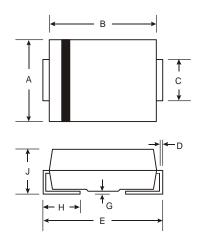








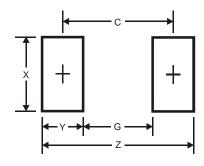
Package Outline Dimensions



SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
Е	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.01	2.30		
All Dimensions in mm				

SMB				
Dim	Min	Max		
Α	3.30	3.94		
В	4.06	4.57		
С	1.96	2.21		
D	0.15	0.31		
Е	5.00	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	2.00	2.50		
All Dimensions in mm				

Suggested Pad Layout



SMA Dimensions	Value (in mm)
Z	6.5
G	1.5
Х	1.7
Y	2.5
С	4.0

SMB Dimensions	Value (in mm)
Z	6.7
G	1.8
Х	2.3
Y	2.5
С	4.3



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